

	Type	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s	E r r o r s
1	BRS	267515	etching (Ti or TiN or titanium or "titanium nitride") same "hard mask"	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/02/11 19:49			0
2	BRS	95856	438/\$.cccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/02/11 19:16			0
3	BRS	1520633	nitrogen or oxygen or carbon or fluorine or boron	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/02/11 19:31			0
4	BRS	87	etching same (Ti or TiN or titanium or "titanium nitride") same "hard mask"	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/02/11 19:50			0
5	BRS	32	(nitrogen or oxygen or carbon or fluorine or boron) same (etching same (Ti or TiN or titanium or "titanium nitride") same "hard mask")	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/02/11 19:49			0
6	BRS	14318	etching same (Ti or TiN or titanium or "titanium nitride")	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/02/11 19:51			0
7	BRS	2327	(nitrogen or oxygen or carbon or fluorine or boron) same (etching same (Ti or TiN or titanium or "titanium nitride"))	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/02/11 19:51			0
8	BRS	843	((nitrogen or oxygen or carbon or fluorine or boron) same (etching same (Ti or TiN or titanium or "titanium nitride")))) and 438/\$.cccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/02/11 19:52			0
9	BRS	858	etch\$3 same (temperature near10 ("80" or "90" or "100" or "200" or "300")) same (Ti or titanium or Al or aluminum or Ta or tantalum or tungsten or W or Mo or molybdenum)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/16 16:44			0
10	BRS	373	(etch\$3 same (temperature near10 ("80" or "90" or "100" or "200" or "300")) same (Ti or titanium or Al or aluminum or Ta or tantalum or tungsten or W or Mo or molybdenum)) and @pd<=19970120	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/16 16:46			0

	Type	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r m e s s a g e s	E r r o r s
11	BRS	373	((etch\$3 same (temperature near10 ("80" or "90" or "100" or "200" or "300")) same (Ti or titanium or Al or aluminum or Ta or tantalum or tungsten or W or Mo or molybdenum)) and @pd<=19970120) and 156/345\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/16 18:23			0
12	BRS	142	((etch\$3 same (temperature near10 ("80" or "90" or "100" or "200" or "300")) same (Ti or titanium or Al or aluminum or Ta or tantalum or tungsten or W or Mo or molybdenum)) and @pd<=19970120) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/16 16:47			0
13	BRS	231	((etch\$3 same (temperature near10 ("80" or "90" or "100" or "200" or "300")) same (Ti or titanium or Al or aluminum or Ta or tantalum or tungsten or W or Mo or molybdenum)) and @pd<=19970120) and 156/345\$.ccls.) not (((etch\$3 same (temperature near10 ("80" or "90" or "100" or "200" or "300")) same (Ti or titanium or Al or aluminum or Ta or tantalum or tungsten or W or Mo or molybdenum)) and @pd<=19970120) and 438/\$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/16 18:23			0
14	BRS	955	etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/20 13:37		Tr u n c a t i o n o v e r f l o w.	1

	Type	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s	E r r o r s
15	BRS	23946	etch\$3 and (Ti or titanium) and (temperature or degree\$) and (dry or plasma or rie or "reactive ion")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/20 13:16	Tr u n c a t i o n o v e r f l o w.	1	
16	BRS	370	(etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/20 17:36		0	
17	BRS	370	(etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/20 17:37	Tr u n c a t i o n o v e r f l o w.	1	
18	BRS	7	((etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120) AND 156/\$.CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/20 17:39		0	
19	BRS	151	((etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120) AND 438/\$.CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/20 17:50		0	

	Type	Hits	Search Text	DBs	Time Stamp	Com ment s	Er ro r m e s s a g e s	Er ro r s
20	BRS	5	((etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120) AND 156/\$.CCLS.) NOT (((etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120) AND 438/\$.CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/20 17:50			0
21	BRS	149	((etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120) AND 438/\$.CCLS.) NOT (((etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120) AND 156/\$.CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/20 17:50			0
22	BRS	149	((etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120) AND 438/\$.CCLS.) NOT (((etch\$3 same (Ti or titanium) same (temperature or degree\$) same (dry or plasma or rie or "reactive ion")) and @pd<=19970120) AND 156/\$.CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 09:33		Tr u n c a t i o n o v e r f l o w.	1
23	BRS	4144	(etch\$ near3 temperature) and (plasma or dry or rie or "reactive ion etch\$")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 09:35		Tr u n c a t i o n o v e r f l o w.	1

	Type	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s	E r r o r s
24	BRS	908	(etch\$ near3 temperature) same (plasma or dry or rie or "reactive ion etch\$") same (substrate or reactor or chamber)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 09:37	Tr u n c a t i o n o v e r f l o w.	1	
25	BRS	436	((etch\$ near3 temperature) same (plasma or dry or rie or "reactive ion etch\$") same (substrate or reactor or chamber)) and @pd<=19970120	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 09:38		0	
26	BRS	163	((etch\$ near3 temperature) same (plasma or dry or rie or "reactive ion etch\$") same (substrate or reactor or chamber)) and @pd<=19970120) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 09:39		0	
27	BRS	49	((etch\$ near3 temperature) same (plasma or dry or rie or "reactive ion etch\$") same (substrate or reactor or chamber)) and @pd<=19970120) and 156/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 09:39		0	